

# 60V, 50A, 13.7mΩ N-channel Power Trench MOSFET

## JMTK50N06B

### Features

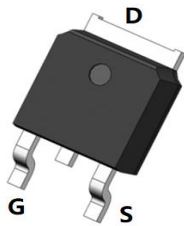
- Excellent  $R_{DS(ON)}$  and Low Gate Charge
- 100% UIS Tested
- 100%  $\Delta V_{ds}$  Tested
- Halogen-free; RoHS-compliant

### Applications

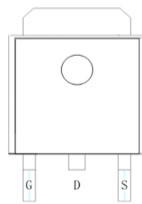
- Load Switch
- PWM Application
- Power Management

### Product Summary

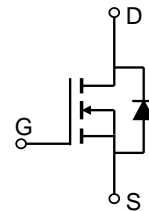
Parameters	Value	Unit
$V_{DSS}$	60	V
$V_{GS(th)_{Typ}}$	1.6	V
$I_D(@V_{GS}=10V)$	50	A
$R_{DS(ON)_{Typ}}(@V_{GS}=10V)$	12.2	mΩ
$R_{DS(ON)_{Typ}}(@V_{GS}=4.5V)$	13.7	mΩ



TO-252-3L



Pin Assignment



Schematic Diagram

### Ordering Information

Device	Marking	MSL	Form	Package	Reel(pcs)	Per Carton (pcs)
JMTK50N06B	JMTK50N06B	3	Tape&Reel	TO-252-3L	2500	25000

### Absolute Maximum Ratings (@ $T_C = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Value	Unit
$V_{DS}$	Drain-to-Source Voltage	60	V
$V_{GS}$	Gate-to-Source Voltage	$\pm 20$	V
$I_D$	Continuous Drain Current	$T_C = 25^\circ\text{C}$	A
		$T_C = 100^\circ\text{C}$	
$I_{DM}$	Pulsed Drain Current <sup>(1)</sup>	Refer to Fig.4	A
$E_{AS}$	Single Pulsed Avalanche Energy <sup>(2)</sup>	59	mJ
$P_D$	Power Dissipation	$T_C = 25^\circ\text{C}$	W
		$T_C = 100^\circ\text{C}$	
$T_J, T_{STG}$	Junction & Storage Temperature Range	-55 to 150	$^\circ\text{C}$

### Thermal Characteristics

Symbol	Parameter	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient <sup>(3)</sup>	49	$^\circ\text{C/W}$
$R_{\theta JC}$	Thermal Resistance, Junction to Case	3.1	

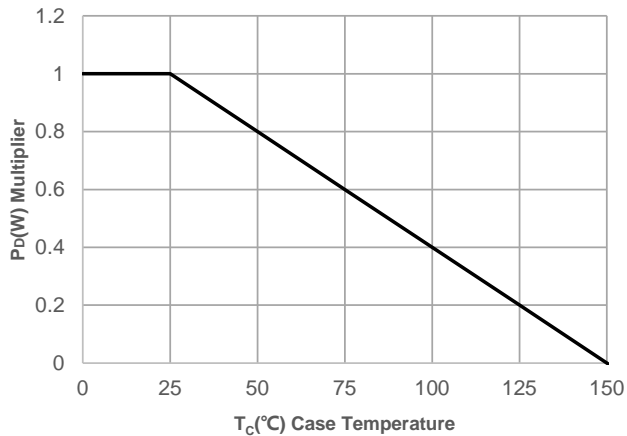
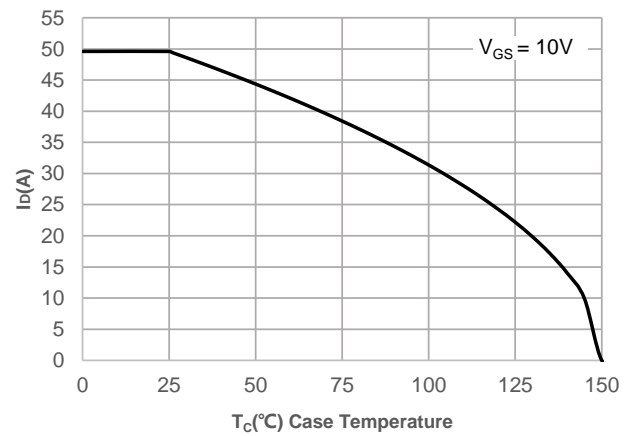
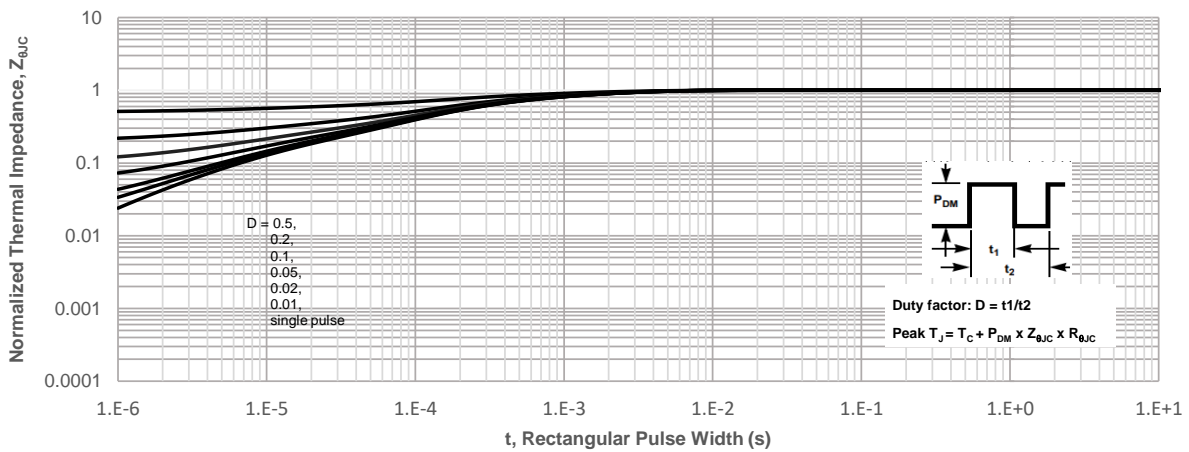
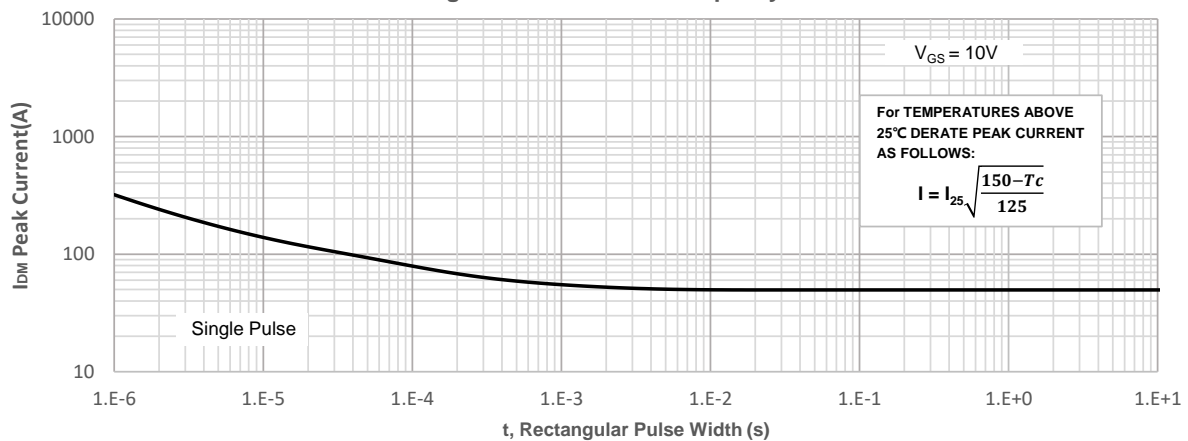
**Electrical Characteristics** ( $T_J = 25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
Off Characteristics						
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V	60	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 60V, V <sub>GS</sub> = 0V	-	-	1.0	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±20V	-	-	±100	nA
On Characteristics						
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	1.1	1.6	2.5	V
R <sub>DS(ON)</sub>	Static Drain-Source ON-Resistance <sup>(4)</sup>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 30A	-	12	15.0	mΩ
		V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 20A	-	14	21.0	mΩ
Dynamic Characteristics						
R <sub>g</sub>	Gate Resistance	f = 1MHz	-	2.4	-	Ω
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 30V, f = 1MHz	1900	2660	3591	pF
C <sub>oss</sub>	Output Capacitance		85	119	161	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		69	96	130	pF
Q <sub>g</sub>	Total Gate Charge	V <sub>GS</sub> = 0 to 10V V <sub>DS</sub> = 30V, I <sub>D</sub> = 30A	36	50	68	nC
Q <sub>gs</sub>	Gate Source Charge		7	10	14	nC
Q <sub>gd</sub>	Gate Drain("Miller") Charge		7	9	12	nC
Switching Characteristics						
t <sub>d(on)</sub>	Turn-On DelayTime	V <sub>GS</sub> = 10V, V <sub>DD</sub> = 30V I <sub>D</sub> = 30A, R <sub>GEN</sub> = 3Ω	-	9	-	ns
t <sub>r</sub>	Turn-On Rise Time		-	31	-	ns
t <sub>d(off)</sub>	Turn-Off DelayTime		-	44	-	ns
t <sub>f</sub>	Turn-Off Fall Time		-	8	-	ns
Body Diode Characteristics						
I <sub>S</sub>	Maximum Continuous Body Diode Forward Current		-	-	50	A
I <sub>SM</sub>	Maximum Pulsed Body Diode Forward Current		-	-	198	A
V <sub>SD</sub>	Body Diode Forward Voltage	V <sub>GS</sub> = 0V, I <sub>S</sub> = 30A	-		1.2	V
trr	Body Diode Reverse Recovery Time	I <sub>F</sub> = 30A, di/dt = 100A/us	16	22	30	ns
Qrr	Body Diode Reverse Recovery Charge		-	25.2	-	nC

- Notes:
1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
  2.  $E_{AS}$  condition: Starting  $T_J = 25^\circ\text{C}$ ,  $V_{DD} = 30\text{V}$ ,  $V_{GS} = 10\text{V}$ ,  $R_G = 25\text{ohm}$ ,  $L = 0.5\text{mH}$ ,  $I_{AS} = 15.96\text{A}$ ,  $V_{DD} = 0\text{V}$  during time in avalanche.
  3.  $R_{\theta JA}$  is measured with the device mounted on a  $1\text{inch}^2$  pad of 2oz copper FR4 PCB.
  4. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 0.5\%$ .



## Typical Performance Characteristics

**Figure 1: Power De-rating**

**Figure 2: Current De-rating**

**Figure 3: Normalized Maximum Transient Thermal Impedance**

**Figure 4: Peak Current Capacity**


## Typical Performance Characteristics

Figure 5: Output Characteristics

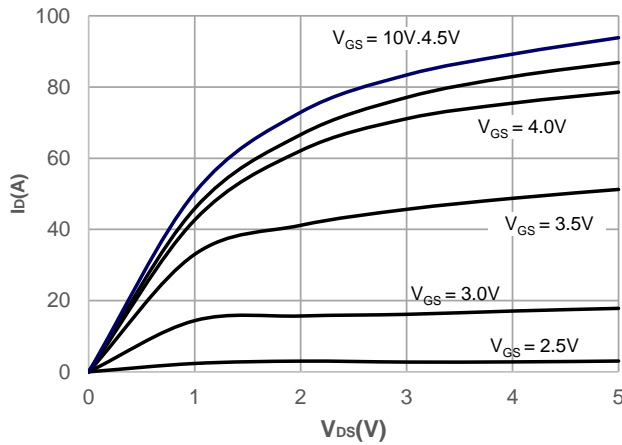


Figure 6: Typical Transfer Characteristics

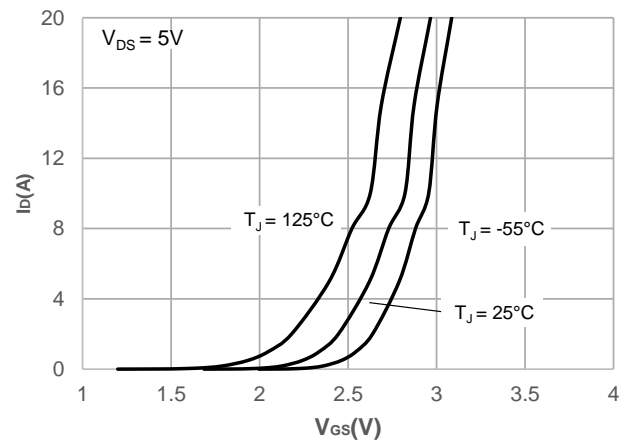


Figure 7: On-resistance vs. Drain Current

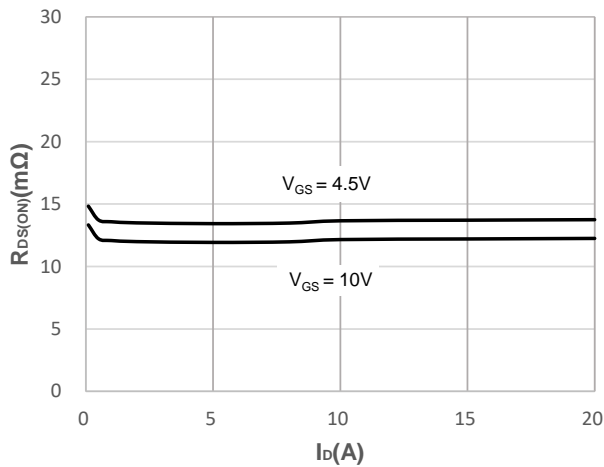


Figure 8: Body Diode Characteristics

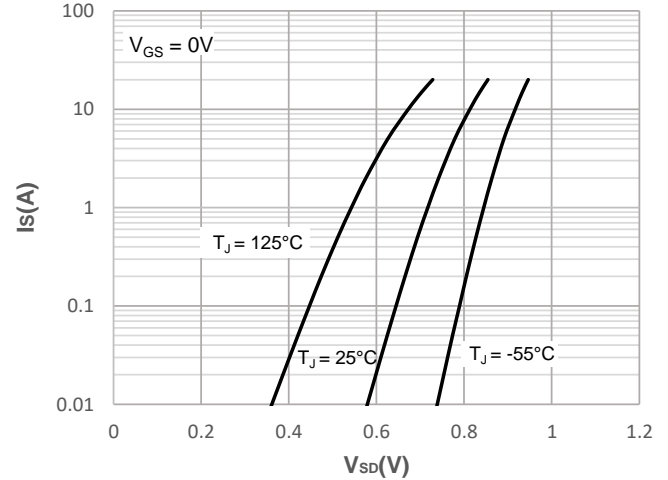


Figure 9: Gate Charge Characteristics

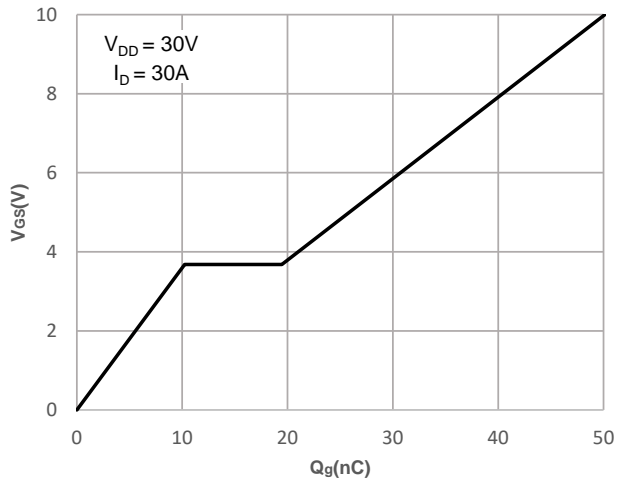
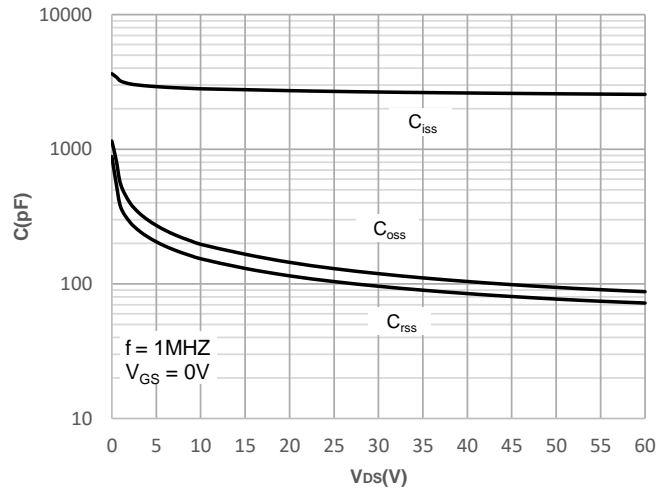
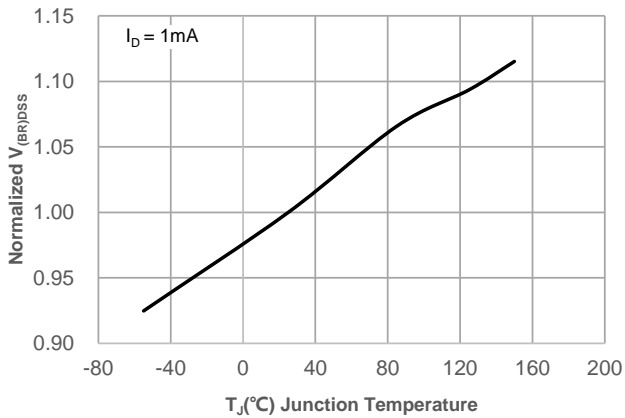


Figure 10: Capacitance Characteristics

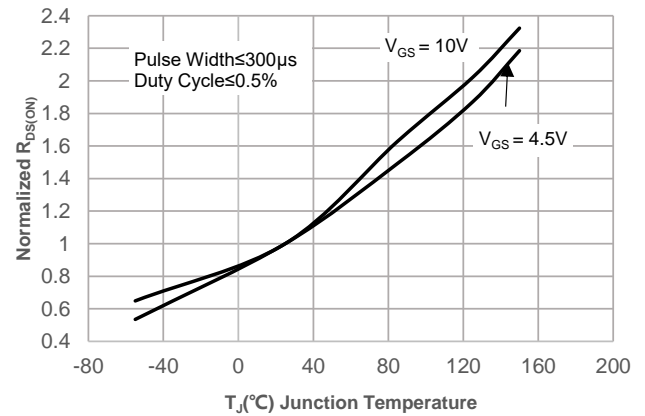


## Typical Performance Characteristics

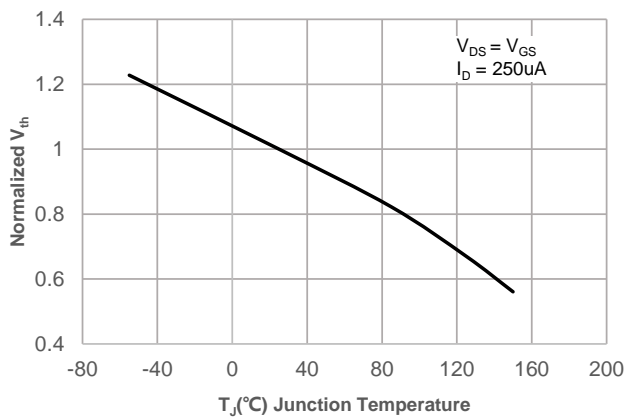
**Figure 11: Normalized Breakdown voltage vs. Junction Temperature**



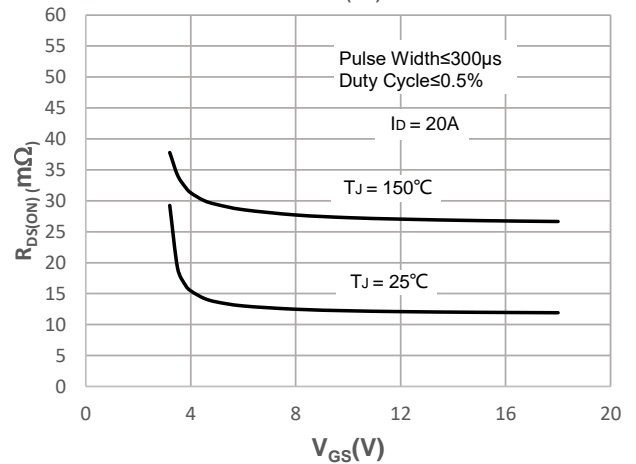
**Figure 12: Normalized on Resistance vs. Junction Temperature**



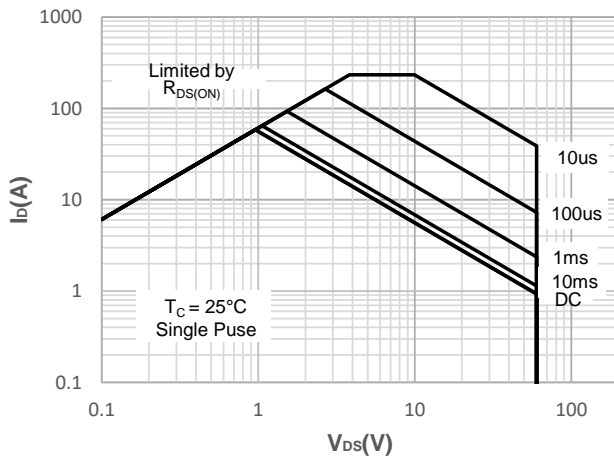
**Figure 13: Normalized Threshold Voltage vs. Junction Temperature**



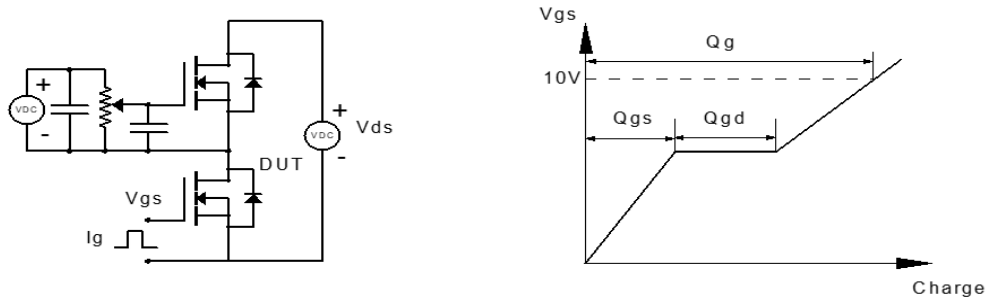
**Figure 14:  $R_{DS(ON)}$  vs.  $V_{GS}$**



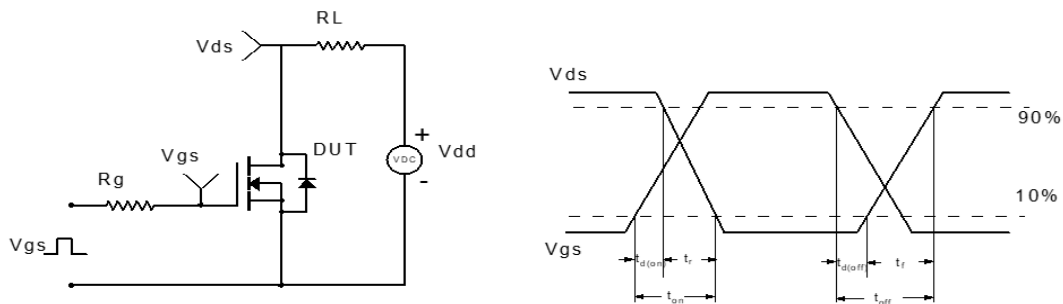
**Figure 15: Maximum Safe Operating Area**



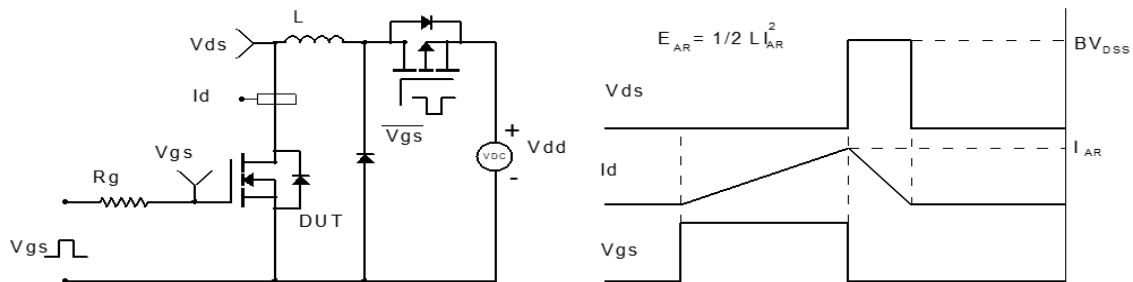
## Test Circuit



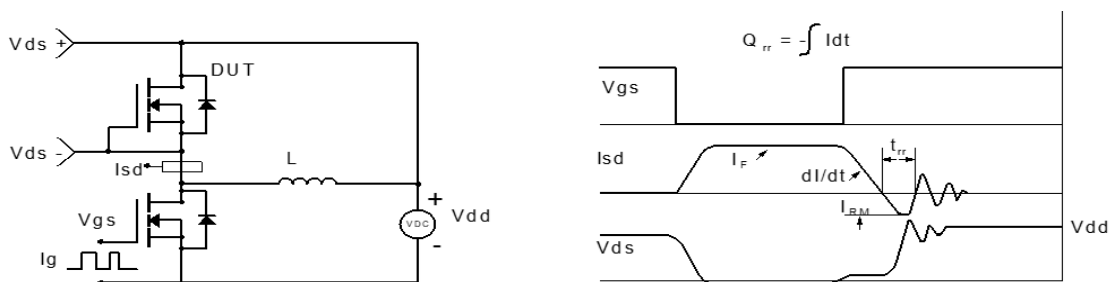
**Figure 1: Gate Charge Test Circuit & Waveform**



**Figure 2: Resistive Switching Test Circuit & Waveform**

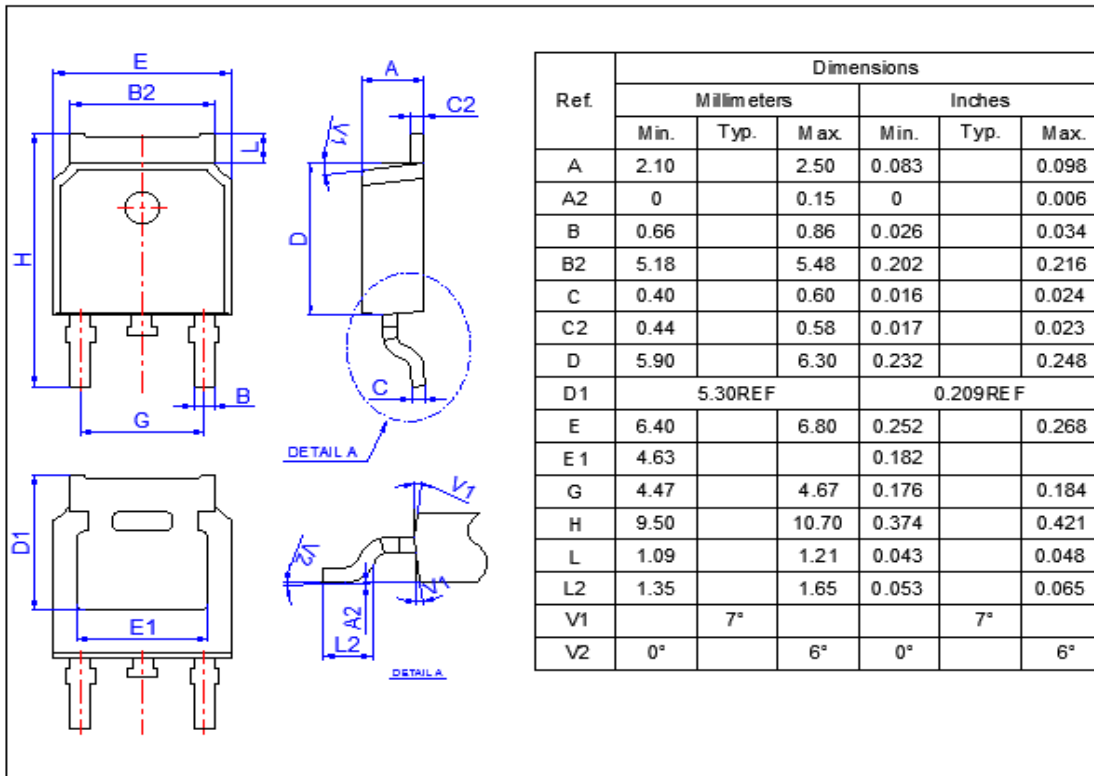


**Figure 3: Unclamped Inductive Switching Test Circuit & Waveform**

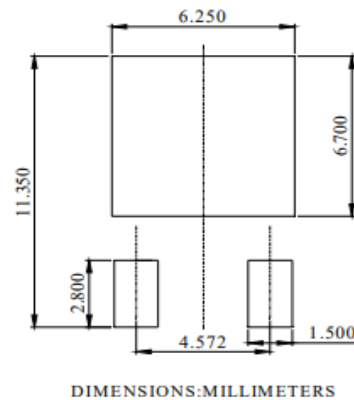


**Figure 4: Diode Recovery Test Circuit & Waveform**

## Package Mechanical Data(TO-252-3L)



### Recommended Soldering Footprint



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